

Electronic Patent Application Fee Transmittal

Application Number:	10581430			
Filing Date:	02-Jun-2006			
Title of Invention:	Bonding method, device produced by this method, and bonding device			
First Named Inventor/Applicant Name:	Masuaki Okada			
Filer:	Ajay A. Jagtiani/g mills			
Attorney Docket Number:	YANE-0002-US1			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1615	14	50	700
Independent claims in excess of 3	1614	6	210	1260
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1960